

TLV2422-Q1, TLV2422A-Q1
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS

SGLS175A – AUGUST 2003 – REVISED APRIL 2008

- Qualified for Automotive Applications
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200 \text{ pF}$, $R = 0$)
- Output Swing Includes Both Supply Rails
- Extended Common-Mode Input Voltage Range . . . 0 V to 4.5 V (Min) With 5-V Single Supply
- No Phase Inversion
- Low Noise . . . 18 nV/ $\sqrt{\text{Hz}}$ Typ at $f = 1 \text{ kHz}$
- Low Input Offset Voltage 950 μV Max at $T_A = 25^\circ\text{C}$ (TLV2422A)
- Low Input Bias Current . . . 1 pA Typ
- Micropower Operation . . . 50 μA Per Channel
- 600- Ω Output Drive

description

The TLV2422 and TLV2422A are dual low-voltage operational amplifiers from Texas Instruments. The common-mode input voltage range for this device has been extended over the typical CMOS amplifiers making them suitable for a wide range of applications. In addition, the devices do not phase invert when the common-mode input is driven to the supply rails. This satisfies most design requirements without paying a premium for rail-to-rail input performance. They also exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. This family is fully characterized at 3-V and 5-V supplies and is optimized for low-voltage operation. The TLV2422 only requires 50 μA of supply current per channel, making it ideal for battery-powered applications. The TLV2422 also has increased output drive over previous rail-to-rail operational amplifiers and can drive 600- Ω loads for telecom applications.

Other members in the TLV2422 family are the high-power, TLV2442, and low-power, TLV2432, versions.

The TLV2422, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels and low-voltage operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLV2422A is available with a maximum input offset voltage of 950 μV .

If the design requires single operational amplifiers, see the TI TLV2211/21/31. This is a family of rail-to-rail output operational amplifiers in the SOT-23 package. Their small size and low power consumption, make them ideal for high density, battery-powered equipment.

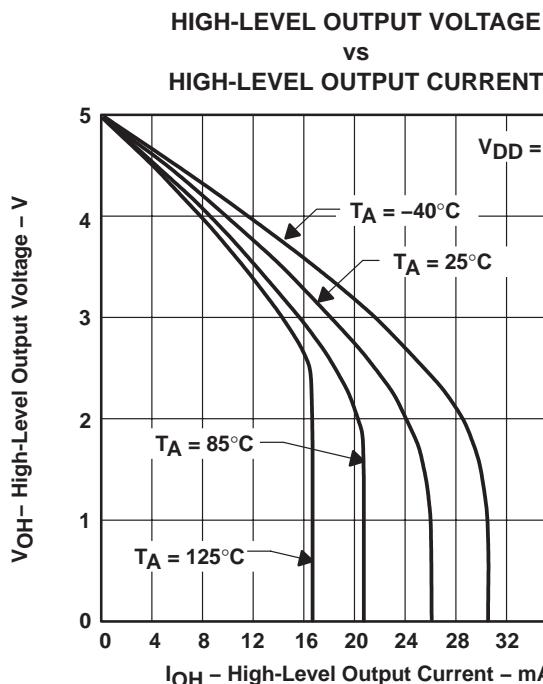
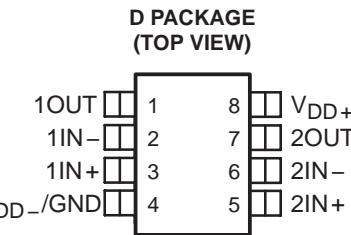


Figure 1



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Advanced LinCMOS is a trademark of Texas Instruments.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Copyright © 2008, Texas Instruments Incorporated

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

TLV2422-Q1, TLV2422A-Q1

Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT

WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS

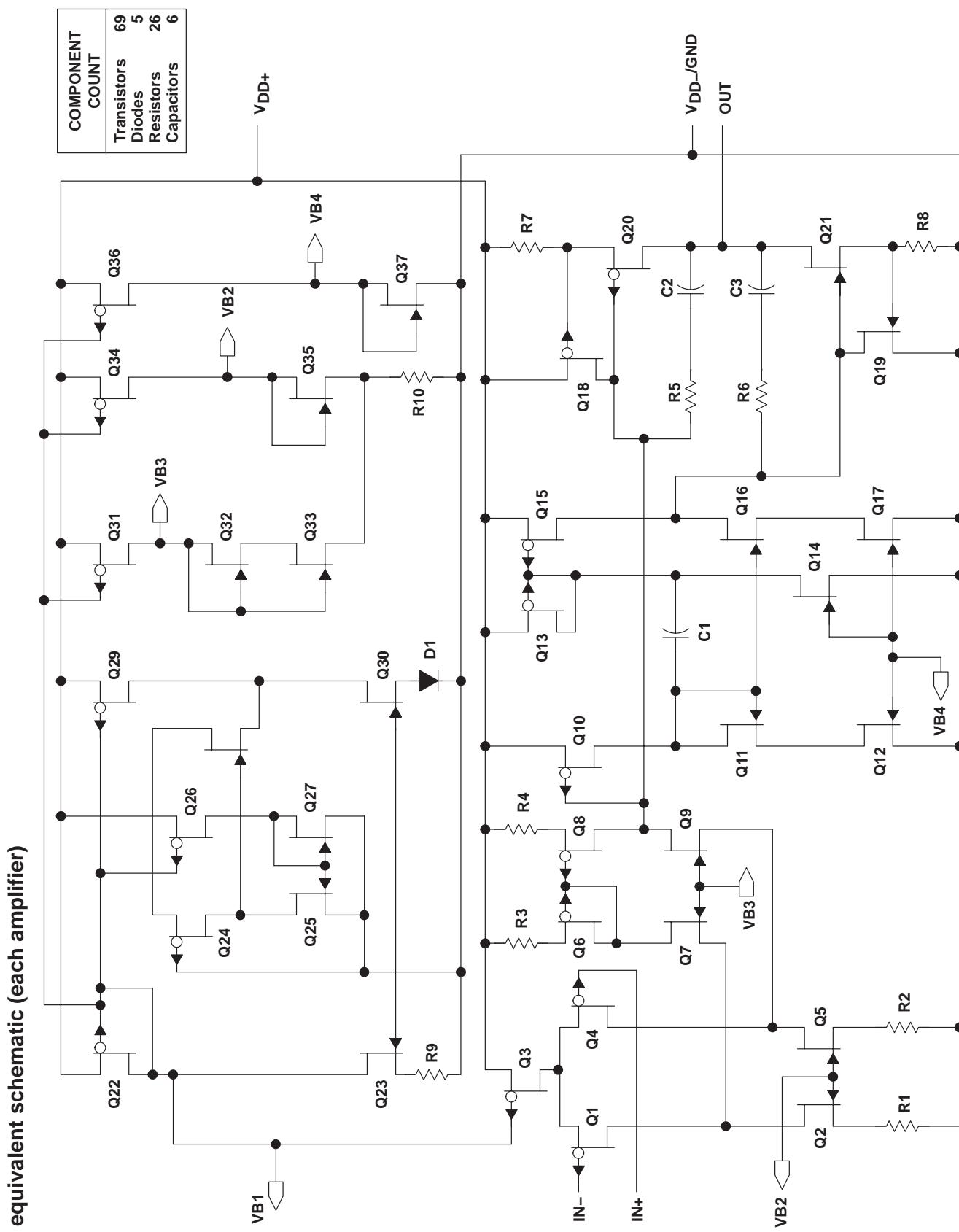
SGLS175A – AUGUST 2003 – REVISED APRIL 2008

ORDERING INFORMATION[†]

T _A	V _{I0max} AT 25°C	PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	950 µV	SOIC (D)	Tape and reel	TLV2422AQDRQ1	2422AQ
	2.5 mV	SOIC (D)	Tape and reel	TLV2422QDRQ1	2422Q1

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at <http://www.ti.com>.

[‡] Package drawings, thermal data, and symbolization are available at <http://www.ti.com/packaging>.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{DD} (see Note 1)	12 V
Differential input voltage, V_{ID} (see Note 2)	$\pm V_{DD}$
Input voltage, V_I (any input, see Note 1): C and I suffix	-0.3 V to V_{DD}
Input current, I_I (each input)	± 5 mA
Output current, I_O	± 50 mA
Total current into V_{DD+}	± 50 mA
Total current out of V_{DD-}	± 50 mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	unlimited
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A : Q suffix	-40°C to 125°C
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages, are with respect to the midpoint between V_{DD+} and V_{DD-} .
 2. Differential voltages are at IN+ with respect to IN-. Excessive current flows if input is brought below $V_{DD-} - 0.3$ V.
 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING	$T_A = 125^\circ\text{C}$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW	145 mW

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, $V_{DD\pm}$	2.7	10	V
Input voltage range, V_I	$V_{DD-} - V_{DD+} - 0.8$		V
Common-mode input voltage, V_{IC}	$V_{DD-} - V_{DD+} - 0.8$		V
Operating free-air temperature, T_A	-40	125	°C

TLV2422-Q1, TLV2422A-Q1
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS
SGS175 – AUGUST 2003

electrical characteristics at specified free-air temperature, $V_{DD} = 3\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV2422-Q1			TLV2422A-Q1			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	$V_{IC} = 0, V_O = 0, V_{DD} = \pm 1.5\text{ V}, R_S = 50\Omega$	25°C	300	2000	300	950			μV
		Full range		2500			1800		
		Full range		2			2		
		25°C	0.003			0.003			
αV_{IO}		25°C	0.5	60	0.5	60			$\mu\text{V}/^\circ\text{C}$
		Full range		150			150		
		25°C	1	60	1	60			
		Full range		300			300		
I_{IO}		25°C	0	-0.25	0	-0.25			pA
			to	to		to			
			2.5	2.75		2.5	2.75		
		Full range	0		0				
I_{IB}		Full range	to	2.2	to	2.2			pA
V_{ICR}	$ V_{IO} \leq 5\text{ mV}, R_S = 50\Omega$	25°C	0	-0.25	0	-0.25			V
			to	to		to			
			2.5	2.75		2.5	2.75		
		Full range	0		0				
V_{OH}	$I_{OH} = -100\text{ }\mu\text{A}$	25°C	2.97		2.97				V
		25°C	2.75		2.75				
		Full range	2.5		2.5				
V_{OL}	$V_{IC} = 0, I_{OL} = 100\text{ }\mu\text{A}$	25°C	0.05		0.05				V
		25°C	0.2		0.2				
		Full range	0.5		0.5				
A_{VD}	$V_{IC} = 1.5\text{ V}, V_O = 1\text{ V to }2\text{ V}$	$R_L = 10\text{ k}\Omega^\ddagger$	25°C	6	10	6	10		V/mV
		Full range	2		2				
		$R_L = 1\text{ M}\Omega^\ddagger$	25°C	700		700			
$r_{i(d)}$	Differential input resistance		25°C	10 ¹²		10 ¹²			Ω
$r_{i(c)}$	Common-mode input resistance		25°C	10 ¹²		10 ¹²			Ω
$c_{i(c)}$	Common-mode input capacitance	$f = 10\text{ kHz}$	25°C	8		8			pF
z_o	Closed-loop output impedance	$f = 100\text{ kHz}, A_V = 10$	25°C	130		130			Ω
$CMRR$	$V_{IC} = V_{ICR} \text{ min}, V_O = 1.5\text{ V}, R_S = 50\Omega$	25°C	70	83	70	83			dB
		Full range	70		70				
k_{SVR}	$V_{DD} = 2.7\text{ V to }8\text{ V}, V_{IC} = V_{DD}/2, \text{ No load}$	25°C	80	95	80	95			dB
		Full range	80		80				
I_{DD}	$V_O = 1.5\text{ V}, \text{ No load}$	25°C	100	150	100	150			μA
		Full range		175		175			

[†] Full range is -40°C to 125°C for Q level part.

[‡] Referenced to 1.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV .

TLV2422-Q1, TLV2422A-Q1**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT****WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS**

SGLS175 – AUGUST 2003

operating characteristics at specified free-air temperature, $V_{DD} = 3\text{ V}$

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV2422-Q1, TLV2422A-Q1			UNIT
			MIN	TYP	MAX	
SR Slew rate at unity gain	$V_O = 1.1\text{ V to }1.9\text{ V}, R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	25°C	0.01	0.02		$\text{V}/\mu\text{s}$
		Full range	0.008			
V_n Equivalent input noise voltage	$f = 10\text{ Hz}$	25°C	100			$\text{nV}/\sqrt{\text{Hz}}$
	$f = 1\text{ kHz}$	25°C	23			
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	$f = 0.1\text{ Hz to }1\text{ Hz}$	25°C	2.7			μV
	$f = 0.1\text{ Hz to }10\text{ Hz}$	25°C	4			
I_n Equivalent input noise current		25°C	0.6			$\text{fA}/\sqrt{\text{Hz}}$
THD + N Total harmonic distortion plus noise	$V_O = 0.5\text{ V to }2.5\text{ V}, f = 1\text{ kHz}, R_L = 10\text{ k}\Omega^\ddagger$	$A_V = 1$		0.25%		
		$A_V = 10$	25°C	1.8%		
Gain-bandwidth product	$f = 10\text{ kHz}, C_L = 100\text{ pF}^\ddagger$	$R_L = 10\text{ k}\Omega^\ddagger$	25°C	46		kHz
BOM Maximum output-swing bandwidth	$V_O(PP) = 1\text{ V}, R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	$A_V = 1, C_L = 100\text{ pF}^\ddagger$	25°C	8.3		kHz
t_s Settling time	$A_V = -1, Step = 0.5\text{ V to }2.5\text{ V}, R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	To 0.1%		8.6		μs
		To 0.01%	25°C	16		
ϕ_m Phase margin at unity gain	$R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	25°C	62°			dB
			25°C	11		

† Full range is -40°C to 125°C for Q level part.

‡ Referenced to 1.5 V



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

TLV2422-Q1, TLV2422A-Q1
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS
SGS175 – AUGUST 2003

electrical characteristics at specified free-air temperature, $V_{DD} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV2422-Q1			TLV2422A-Q1			UNIT	
			MIN	TYP	MAX	MIN	TYP	MAX		
V_{IO} Input offset voltage	$V_{IC} = 0, V_O = 0, V_{DD} \pm 2.5\text{ V}, R_S = 50\Omega$	25°C	300	2000	300	300	950	1800	μV	
		Full range		2500						
		Full range		2			2		$\mu\text{V}/^\circ\text{C}$	
		25°C	0.003			0.003			$\mu\text{V}/\text{mo}$	
		25°C	0.5	60	0.5	60			pA	
I_{IO} Input offset current		Full range		150			150			
		25°C	1	60	1	60			pA	
		Full range		300			300			
V_{ICR} Common-mode input voltage range	$ V_{IO} \leq 5\text{ mV}, R_S = 50\Omega$	25°C	0 to 4.5	-0.25 to 4.75	0 to 4.75	0 to 4.5	-0.25 to 4.75	0 to 4.75	V	
		Full range	0 to 4.2	0 to 4.2	0 to 4.2	0 to 4.2	0 to 4.2	0 to 4.2		
		25°C	4.97			4.97			V	
		25°C	4.75			4.75				
V_{OL} Low-level output voltage	$V_{IC} = 2.5\text{ V}, I_{OL} = 100\mu\text{A}$	Full range	4.5			4.5			V	
		25°C	0.04			0.04				
		25°C	0.15			0.15				
		Full range		0.5			0.5			
A_{VD} Large-signal differential voltage amplification	$V_{IC} = 2.5\text{ V}, V_O = 1\text{ V to }4\text{ V}$	$R_L = 10\text{ k}\Omega^\ddagger$	25°C	8	12	8	12		V/mV	
		$R_L = 1\text{ M}\Omega^\ddagger$	Full range	3		3				
		$R_L = 1\text{ M}\Omega^\ddagger$	25°C	1000		1000				
			25°C	10 ¹²		10 ¹²				
$r_{i(d)}$ Differential input resistance			25°C						Ω	
$r_{i(c)}$ Common-mode input resistance			25°C			10 ¹²			Ω	
$C_{i(c)}$ Common-mode input capacitance	$f = 10\text{ kHz}$		25°C		8		8		pF	
Z_O Closed-loop output impedance	$f = 100\text{ kHz}, A_V = 10$		25°C		130		130		Ω	
$CMRR$ Common-mode rejection ratio	$V_{IC} = V_{ICR} \text{ min}, V_O = 2.5\text{ V}, R_S = 50\Omega$	25°C	70	90	70	90			dB	
		Full range	70		70					
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	$V_{DD} = 4.4\text{ V to }8\text{ V}, V_{IC} = V_{DD}/2, \text{ No load}$	25°C	80	95	80	95			dB	
		Full range	80		80					
I_{DD} Supply current	$V_O = 2.5\text{ V}, \text{ No load}$	25°C	100	150	100	150			μA	
		Full range		175			175			

[†] Full range is -40°C to 125°C for Q level part.

[‡] Referenced to 2.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV .

TLV2422-Q1, TLV2422A-Q1

Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT

WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS

SGLS175 – AUGUST 2003

operating characteristics at specified free-air temperature, $V_{DD} = 5\text{ V}$

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV2422-Q1, TLV2422A-Q1			UNIT
			MIN	TYP	MAX	
SR Slew rate at unity gain	$V_O = 1.5\text{ V to }3.5\text{ V}, R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	25°C	0.01	0.02		$\text{V}/\mu\text{s}$
		Full range	0.008			
V_n Equivalent input noise voltage	$f = 10\text{ Hz}$	25°C	100			$\text{nV}/\sqrt{\text{Hz}}$
	$f = 1\text{ kHz}$	25°C	18			
$V_N(\text{PP})$ Peak-to-peak equivalent input noise voltage	$f = 0.1\text{ Hz to }1\text{ Hz}$	25°C	1.9			μV
	$f = 0.1\text{ Hz to }10\text{ Hz}$	25°C	2.8			
I_n Equivalent input noise current		25°C	0.6			$\text{fA}/\sqrt{\text{Hz}}$
THD + N Total harmonic distortion plus noise	$V_O = 1.5\text{ V to }3.5\text{ V}, f = 1\text{ kHz}, R_L = 10\text{ k}\Omega^\ddagger$	$A_V = 1$		0.24%		
		$A_V = 10$		1.7%		
Gain-bandwidth product	$f = 10\text{ kHz}, C_L = 100\text{ pF}^\ddagger$	$R_L = 10\text{ k}\Omega^\ddagger$	25°C	52		kHz
BOM Maximum output-swing bandwidth	$V_O(\text{PP}) = 2\text{ V}, R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	$A_V = 1, C_L = 100\text{ pF}^\ddagger$	25°C	5.3		kHz
t_s Settling time	$A_V = -1, \text{Step} = 1.5\text{ V to }3.5\text{ V}, R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	To 0.1%		8.5		μs
		To 0.01%		15.5		
ϕ_m Phase margin at unity gain	$R_L = 10\text{ k}\Omega^\ddagger, C_L = 100\text{ pF}^\ddagger$	25°C	66°			
		25°C	11			dB

† Full range is -40°C to 125°C for Q level part.‡ Referenced to 2.5 V

TYPICAL CHARACTERISTICS

Table of Graphs

		FIGURE
V_{IO}	Input offset voltage	Distribution vs Common-mode input voltage 2,3 4,5
αV_{IO}	Input offset voltage temperature coefficient	Distribution 6,7
I_{IB}/I_{IO}	Input bias and input offset currents	vs Free-air temperature 8
V_{OH}	High-level output voltage	vs High-level output current 9,11
V_{OL}	Low-level output voltage	vs Low-level output current 10,12
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency 13
I_{OS}	Short-circuit output current	vs Supply voltage 14 vs Free-air temperature 15
V_{ID}	Differential input voltage	vs Output voltage 16,17
	Differential gain	vs Load resistance 18
A_{VD}	Large-signal differential voltage amplification	vs Frequency 19,20
	Differential voltage amplification	vs Free-air temperature 21,22
z_0	Output impedance	vs Frequency 23,24
$CMRR$	Common-mode rejection ratio	vs Frequency 25 vs Free-air temperature 26
k_{SVR}	Supply-voltage rejection ratio	vs Frequency 27,28 vs Free-air temperature 29
I_{DD}	Supply current	vs Supply voltage 30
SR	Slew rate	vs Load capacitance 31 vs Free-air temperature 32
V_O	Inverting large-signal pulse response	33,34
V_O	Voltage-follower large-signal pulse response	35,36
V_O	Inverting small-signal pulse response	37,38
V_O	Voltage-follower small-signal pulse response	39,40
V_n	Equivalent input noise voltage	vs Frequency 41, 42
	Noise voltage (referred to input)	Over a 10-second period 43
$THD + N$	Total harmonic distortion plus noise	vs Frequency 44,45
	Gain-bandwidth product	vs Supply voltage 46 vs Free-air temperature 47
ϕ_m	Phase margin	vs Frequency 19,20 vs Load capacitance 48
	Gain margin	vs Load capacitance 49
B_1	Unity-gain bandwidth	vs Load capacitance 50

TLV2422-Q1, TLV2422A-Q1
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS

SGLS175 – AUGUST 2003

TYPICAL CHARACTERISTICS

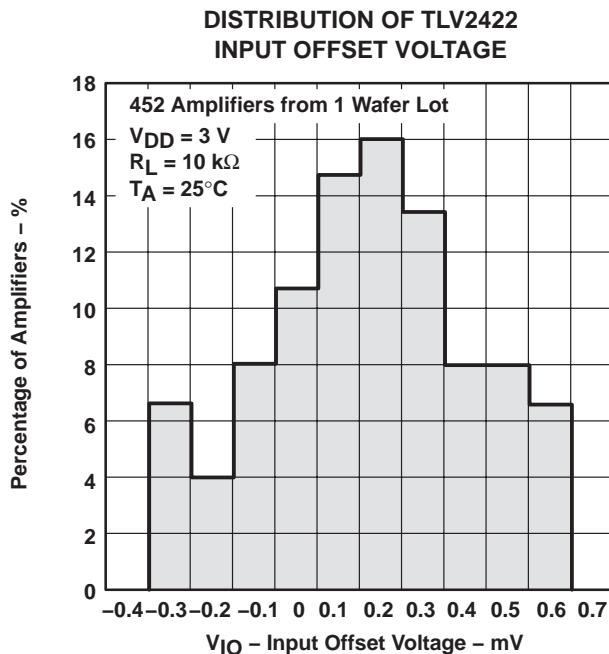


Figure 2

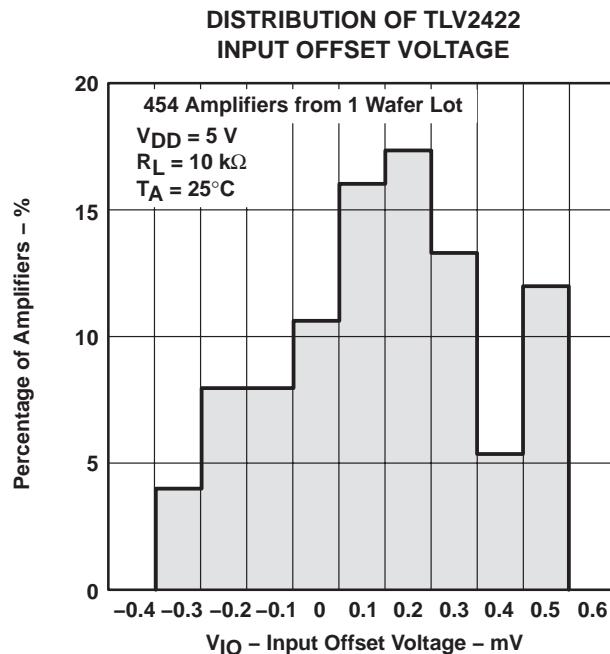


Figure 3

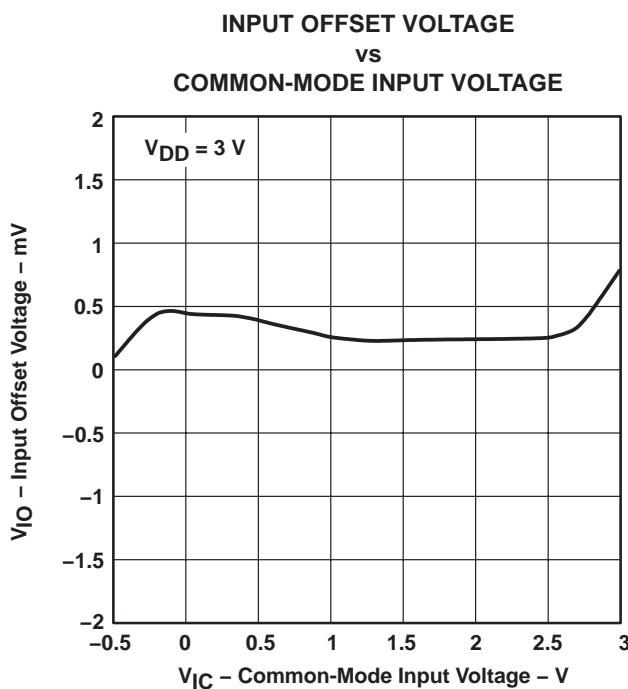


Figure 4

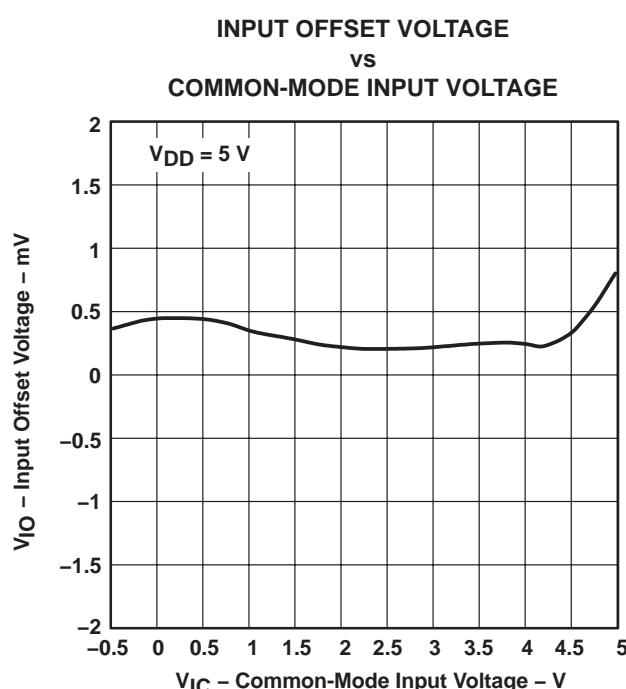


Figure 5

TYPICAL CHARACTERISTICS

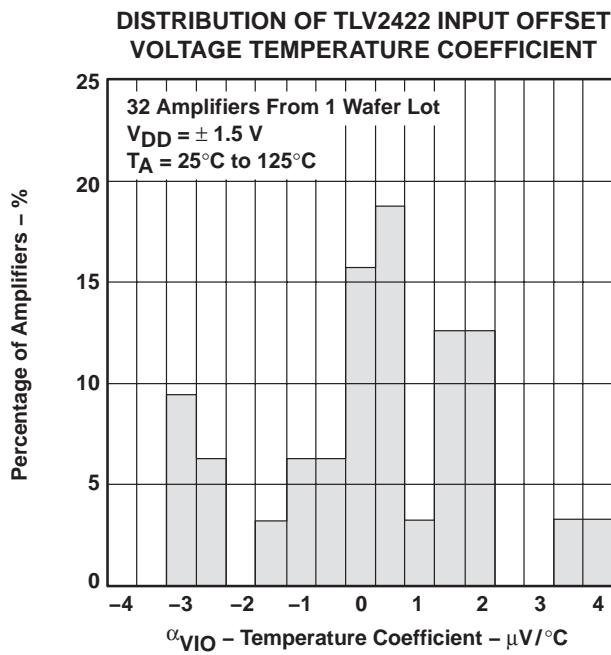


Figure 6

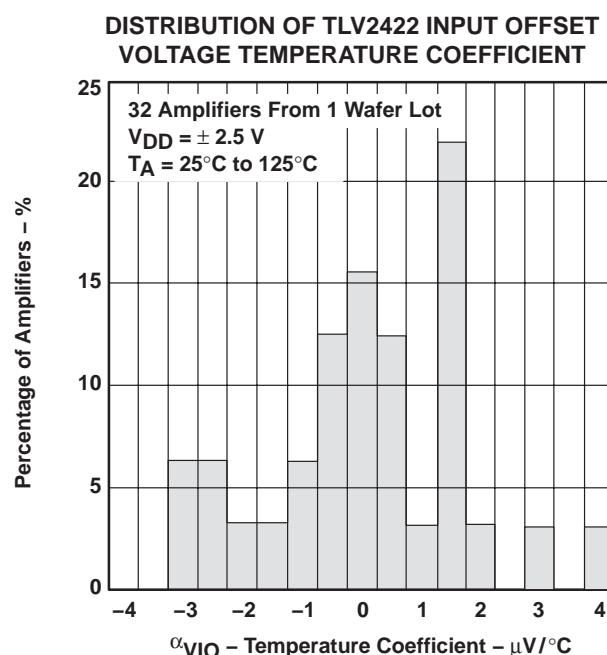


Figure 7

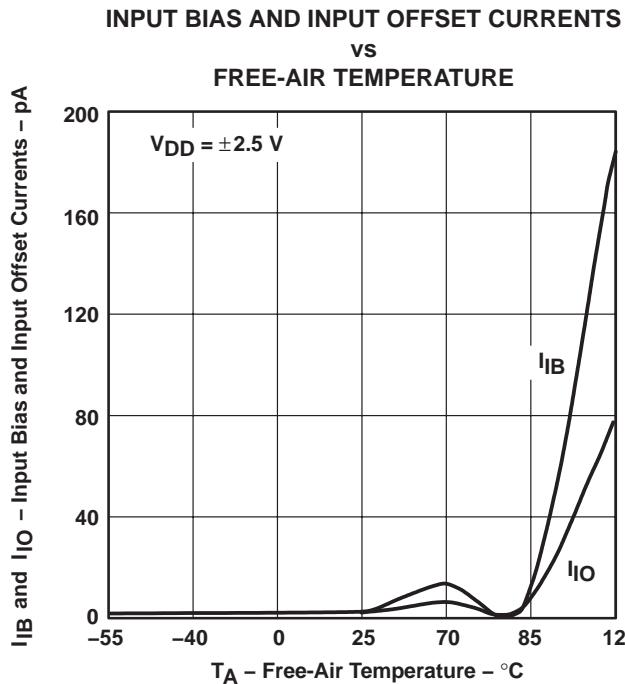


Figure 8

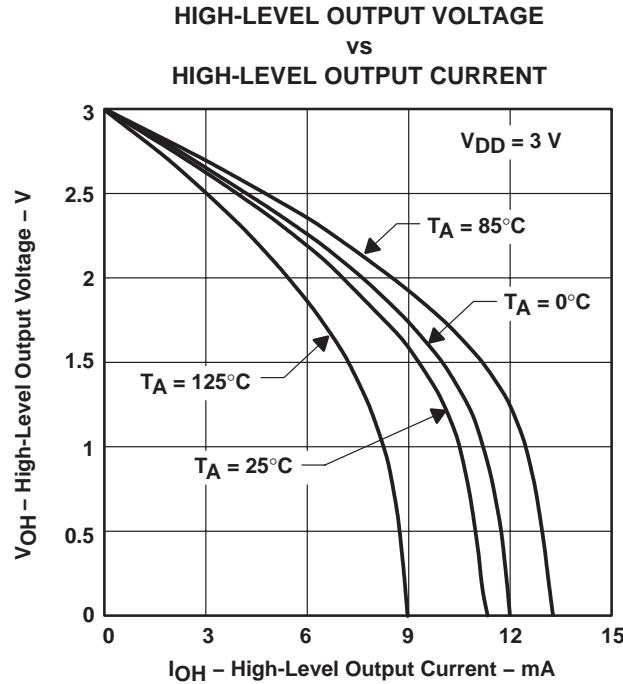


Figure 9

TLV2422-Q1, TLV2422A-Q1
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS

SGLS175 – AUGUST 2003

TYPICAL CHARACTERISTICS

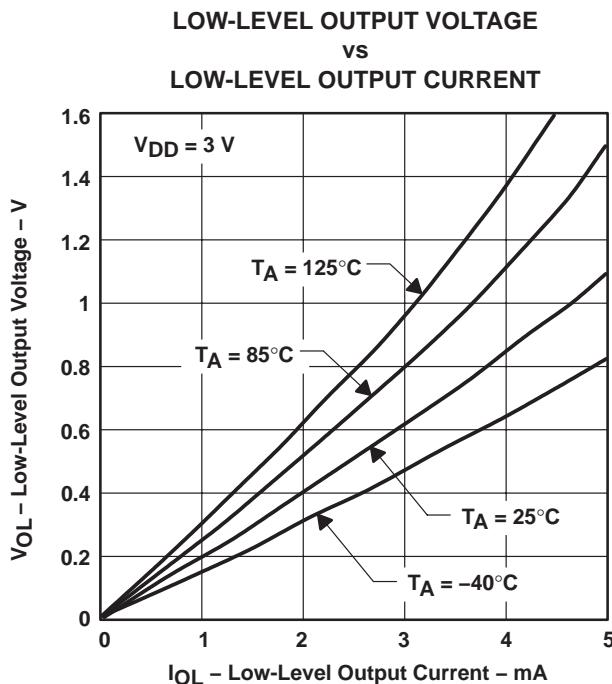


Figure 10

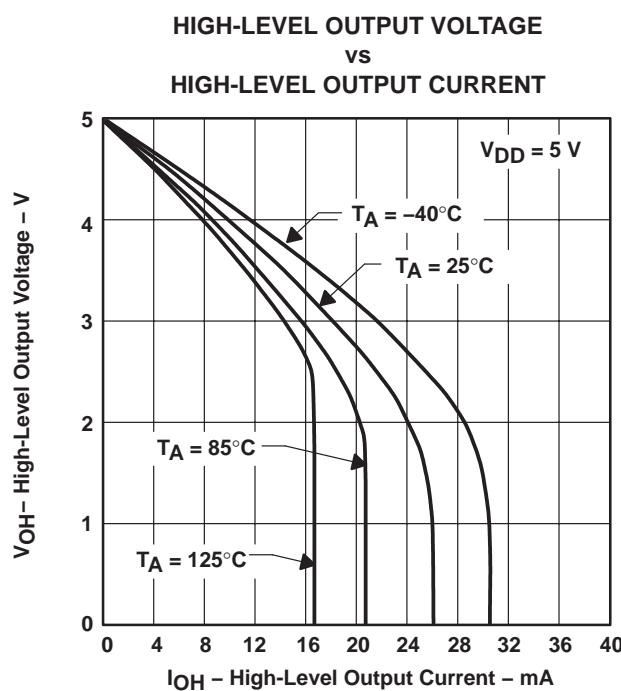


Figure 11

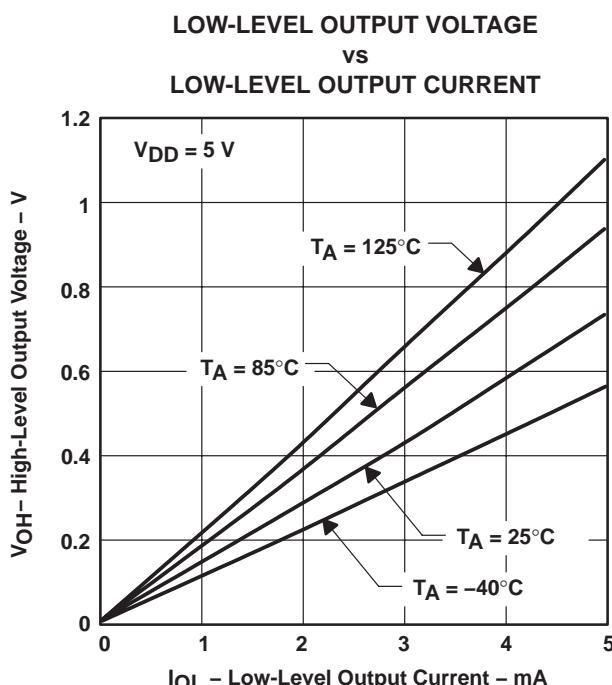


Figure 12

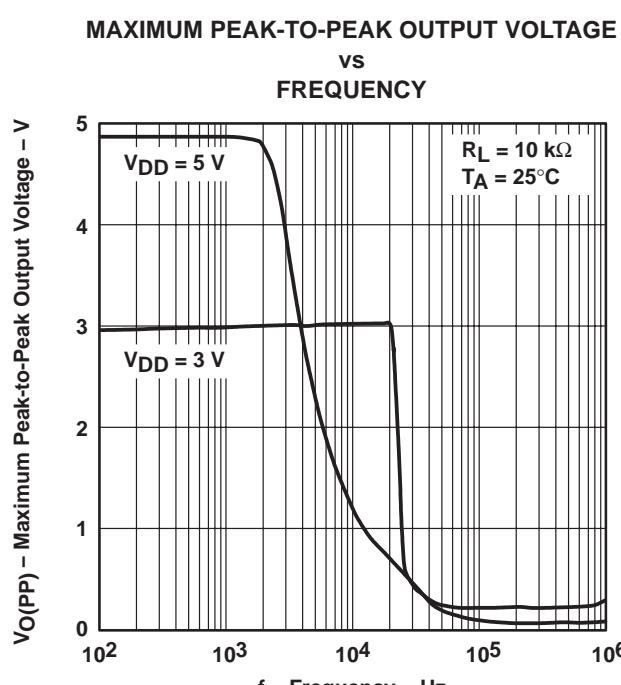


Figure 13

TYPICAL CHARACTERISTICS

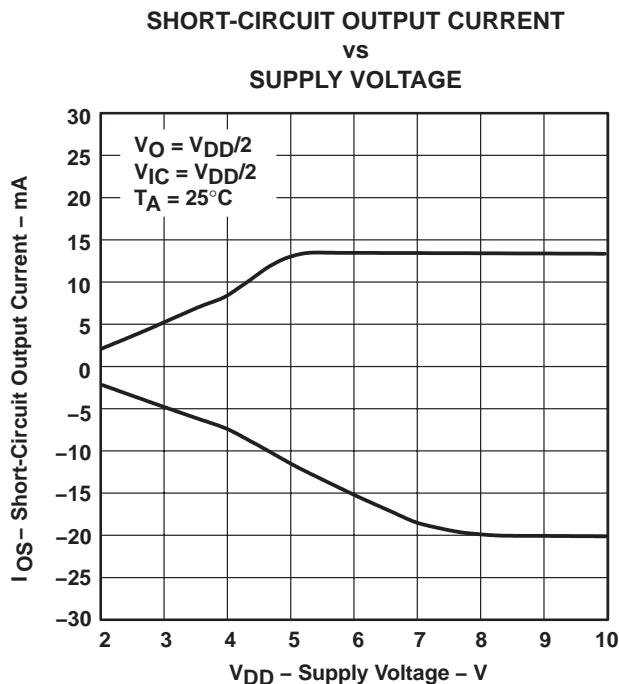


Figure 14

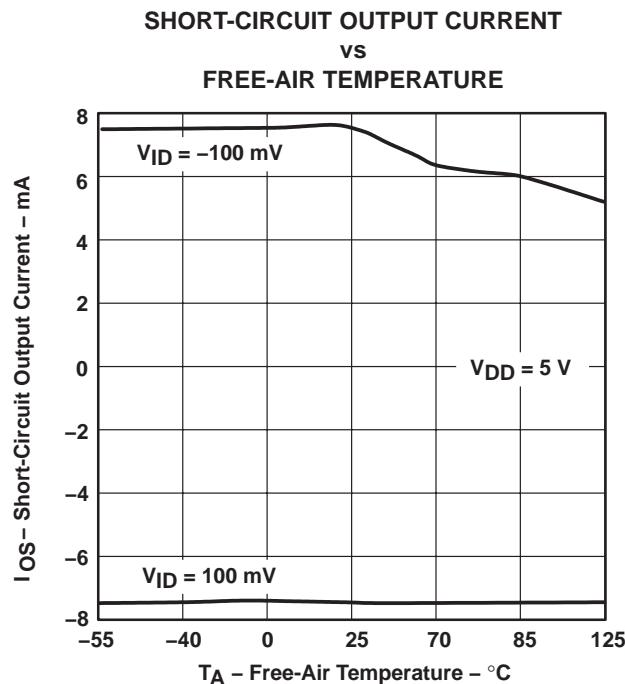


Figure 15

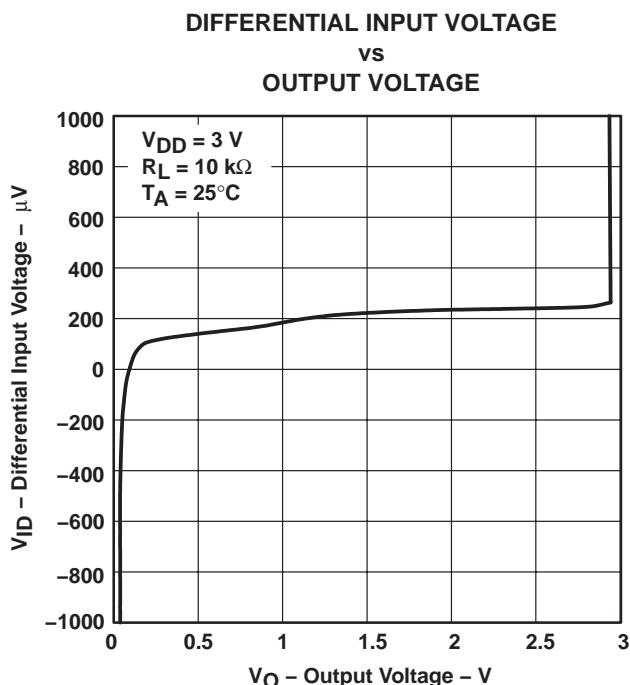


Figure 16

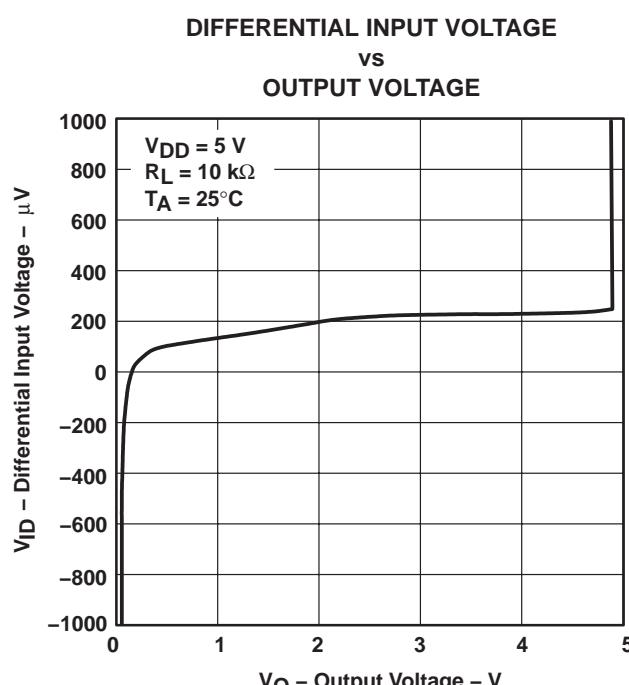


Figure 17

TYPICAL CHARACTERISTICS

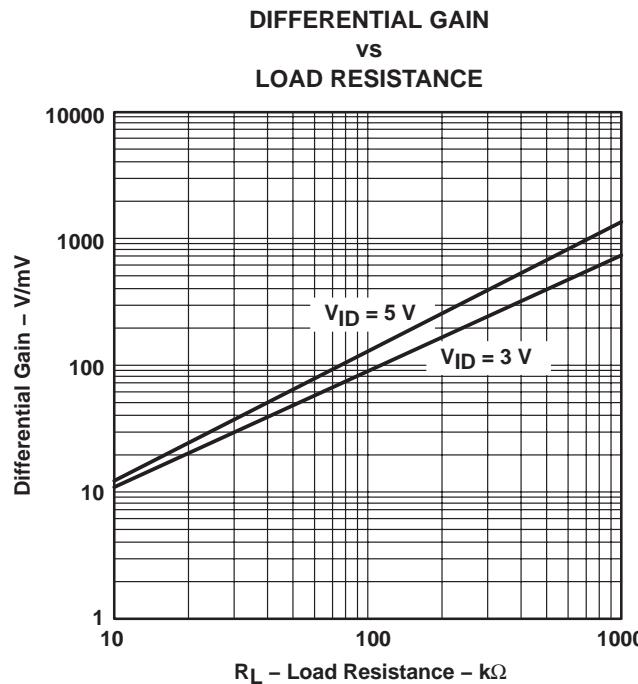


Figure 18

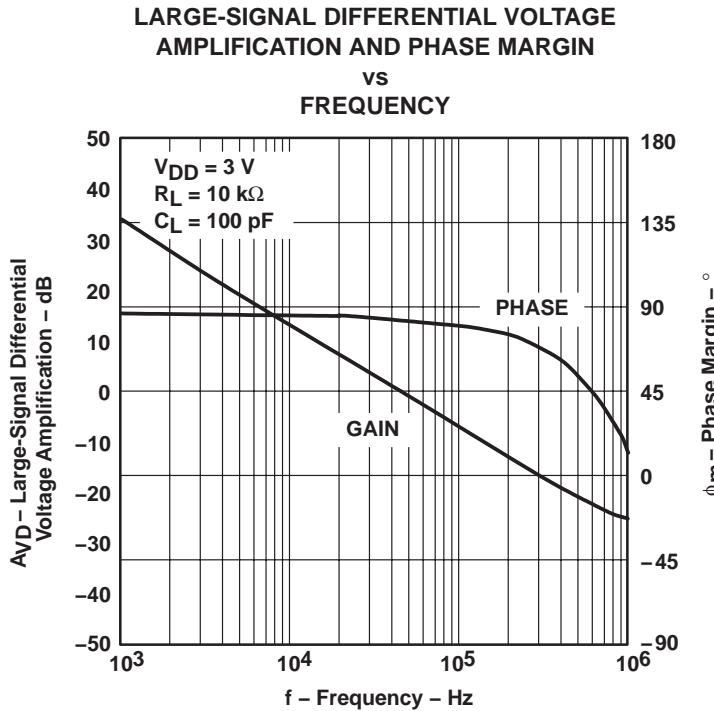


Figure 19

TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE MARGIN
vs
FREQUENCY

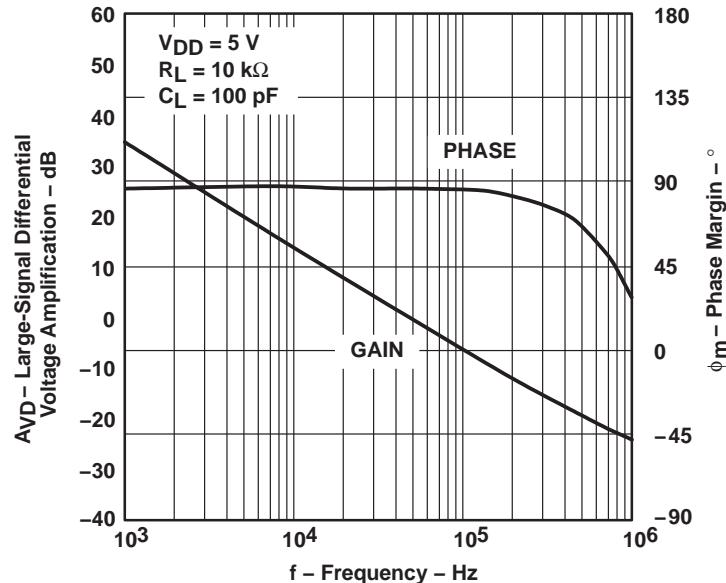


Figure 20

DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE

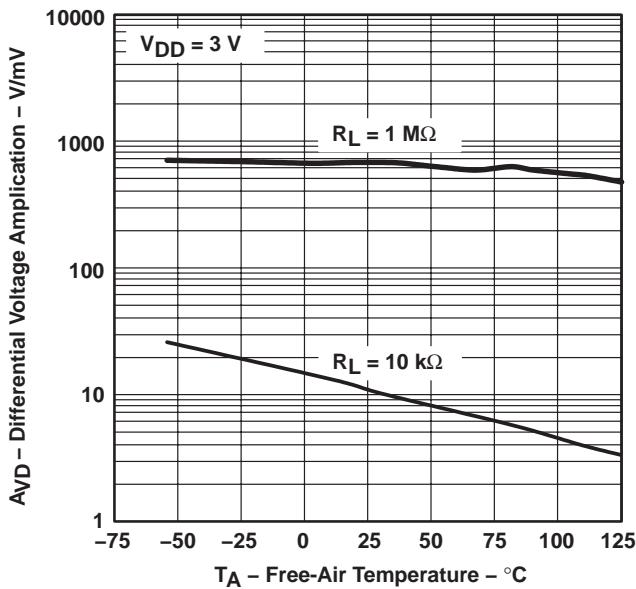


Figure 21

DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE

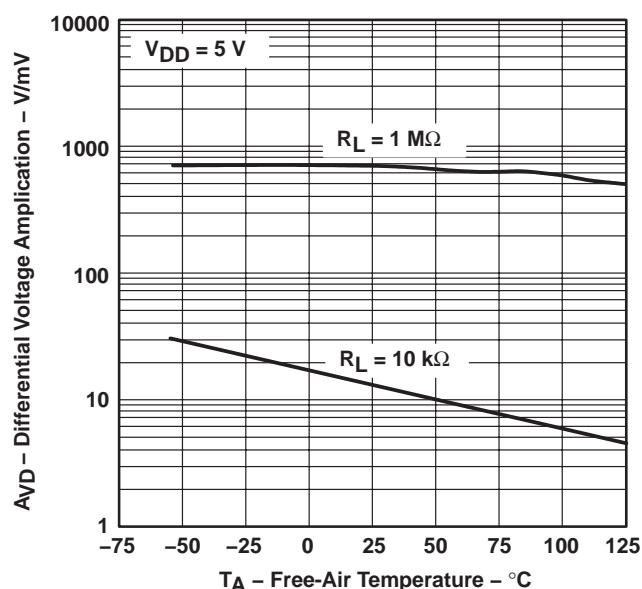


Figure 22

TLV2422-Q1, TLV2422A-Q1
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS

SGLS175 – AUGUST 2003

TYPICAL CHARACTERISTICS

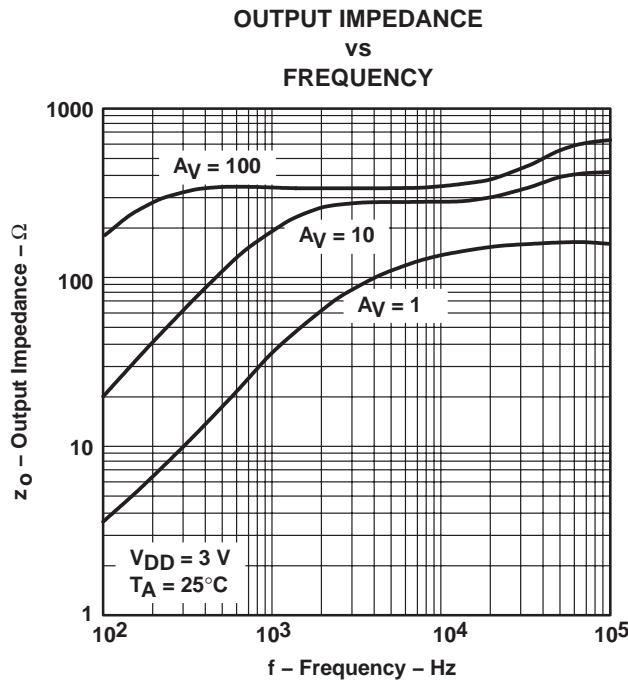


Figure 23

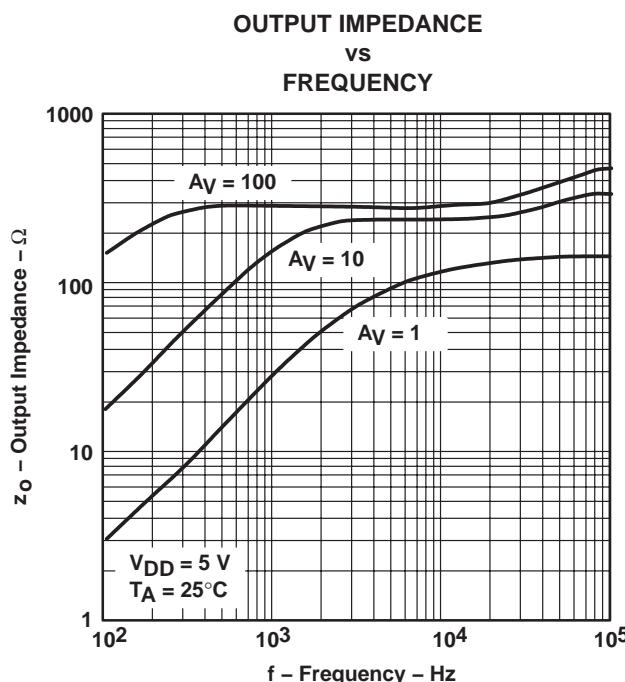


Figure 24

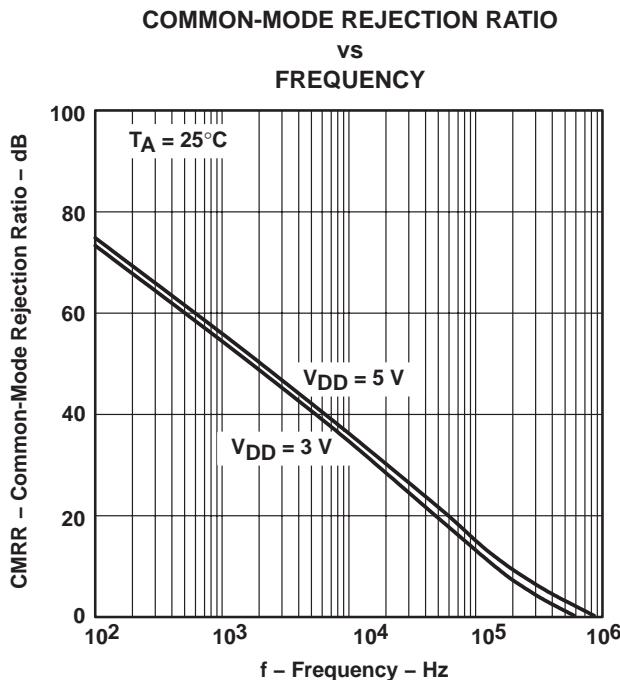


Figure 25

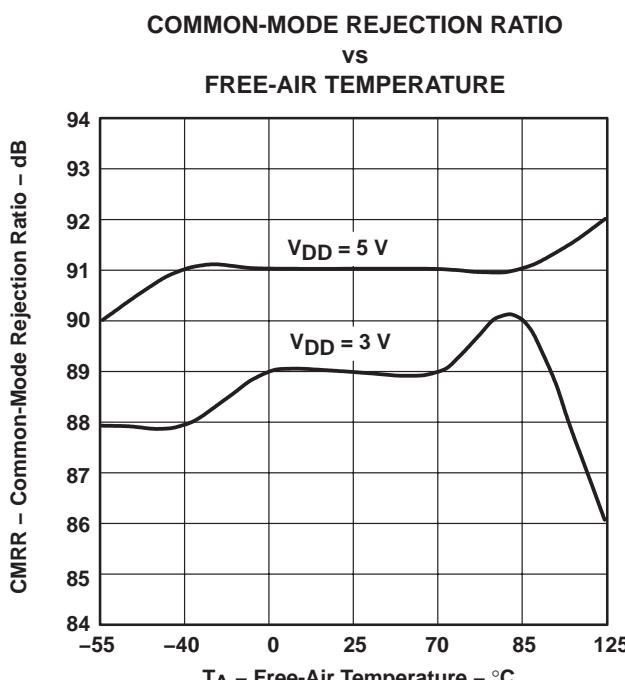


Figure 26

TYPICAL CHARACTERISTICS

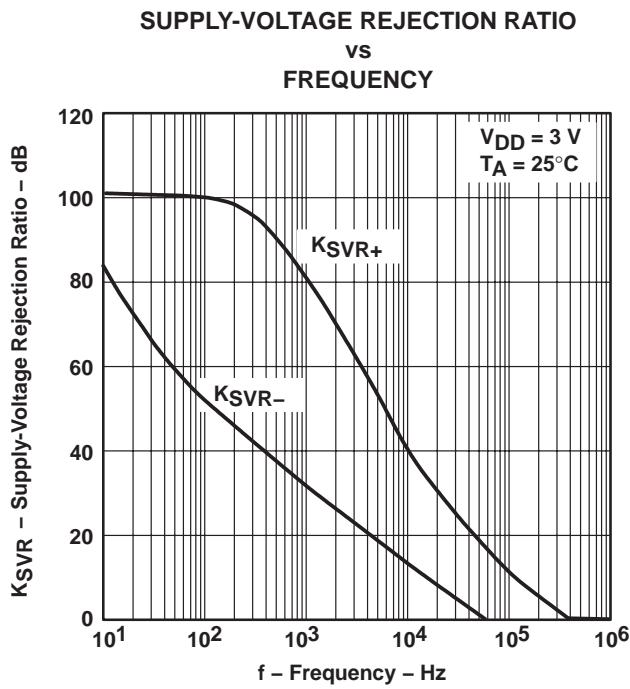


Figure 27

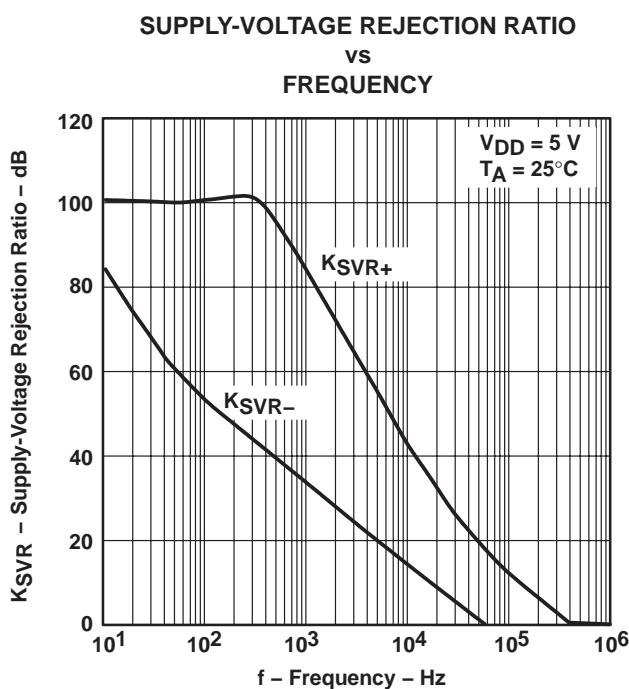


Figure 28

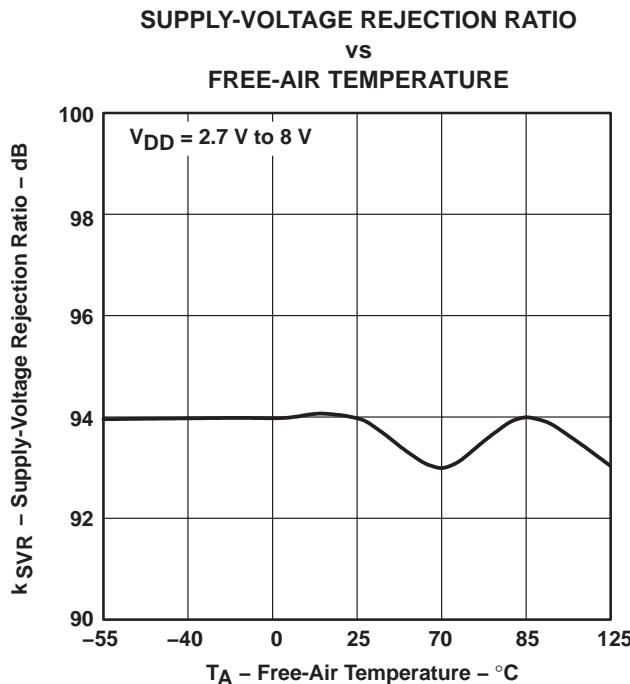


Figure 29

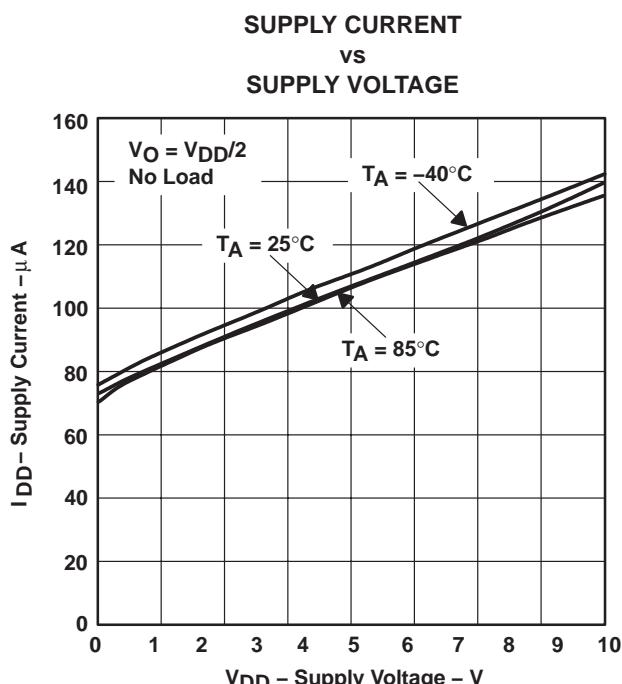


Figure 30

TYPICAL CHARACTERISTICS

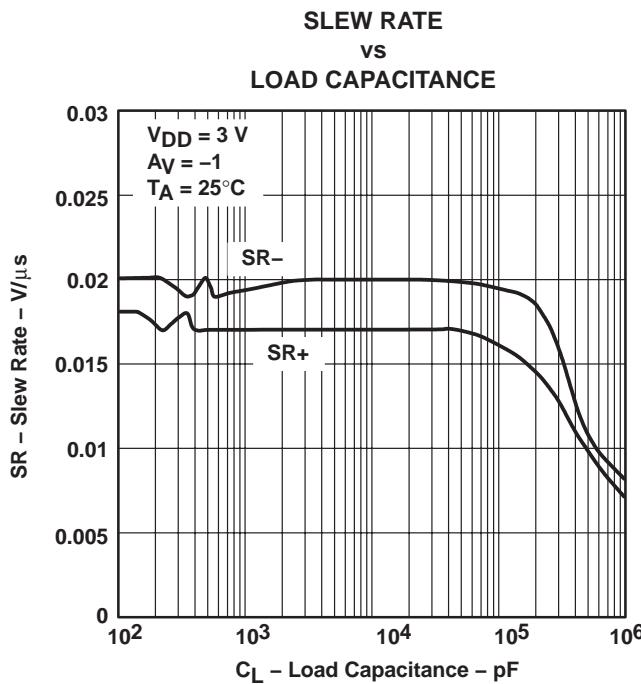


Figure 31

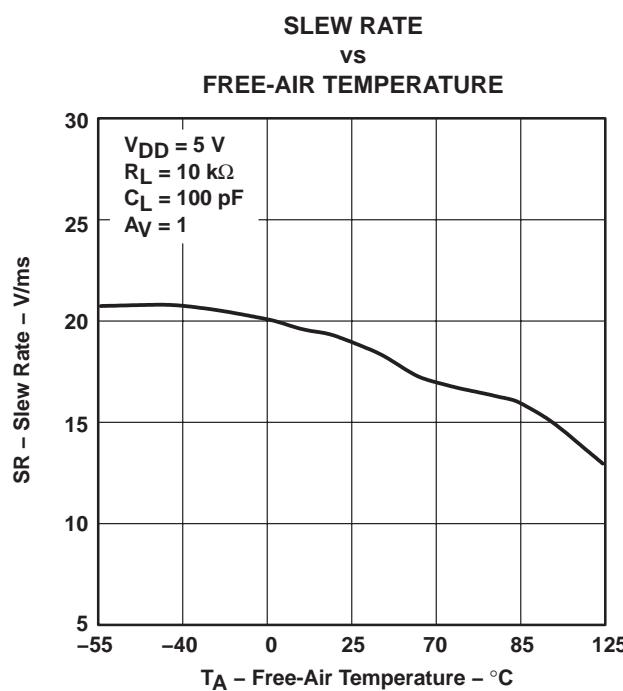


Figure 32

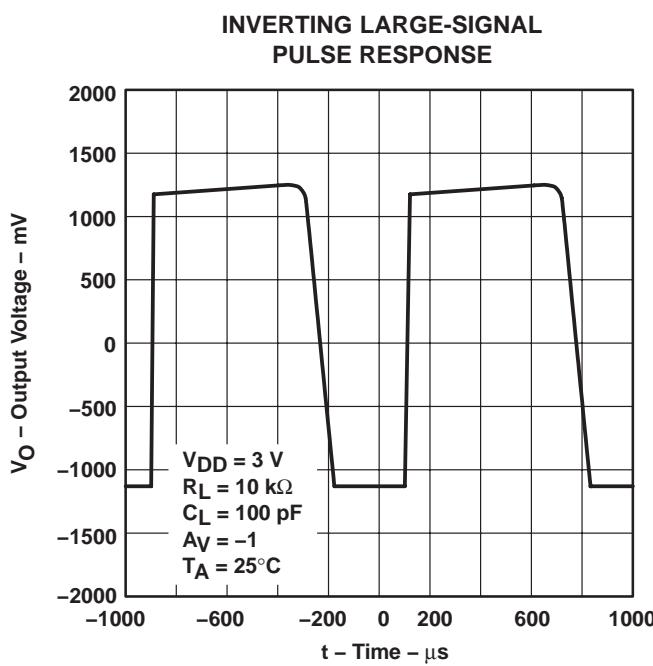


Figure 33

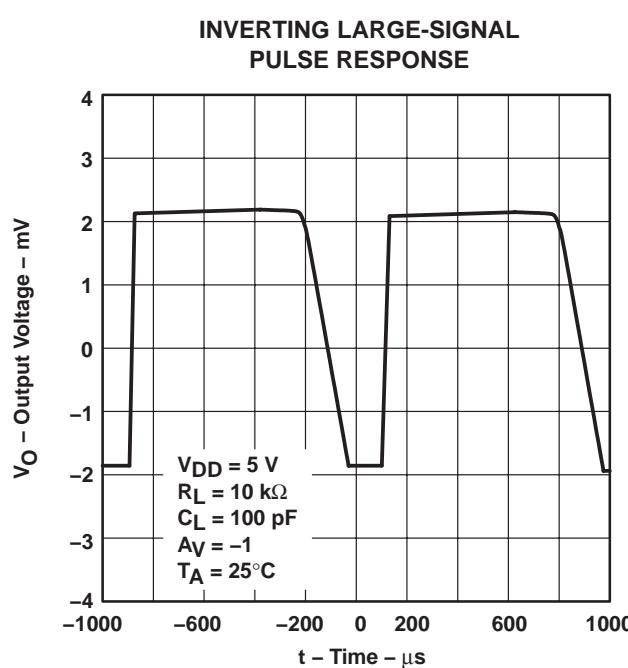


Figure 34

TYPICAL CHARACTERISTICS

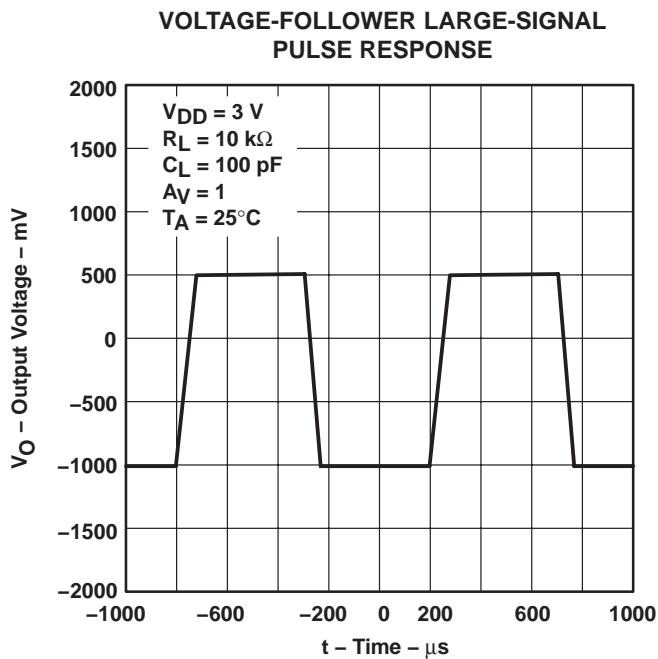


Figure 35

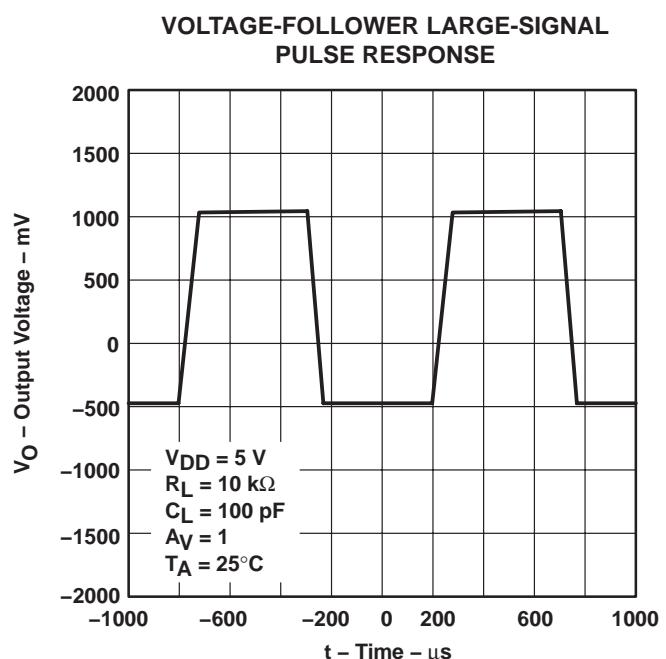


Figure 36

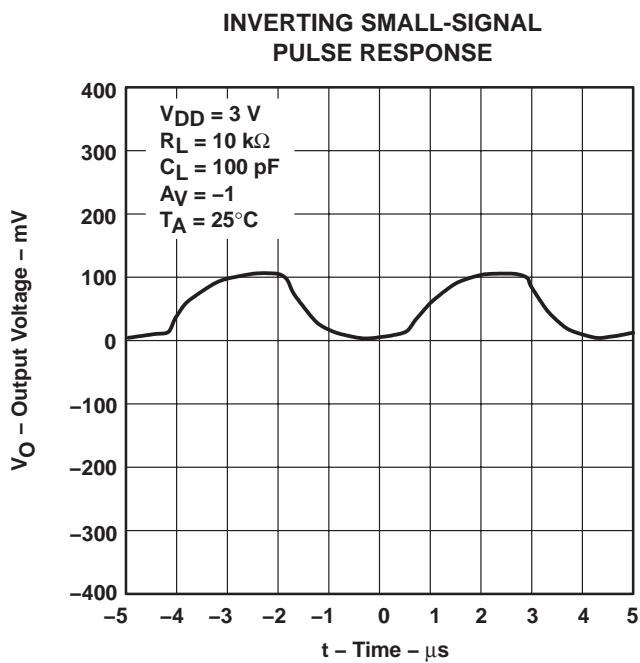


Figure 37

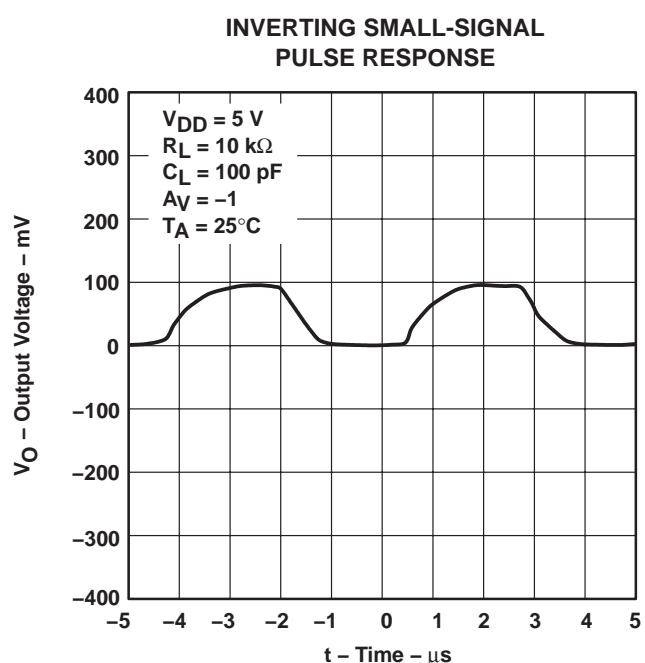


Figure 38

TYPICAL CHARACTERISTICS

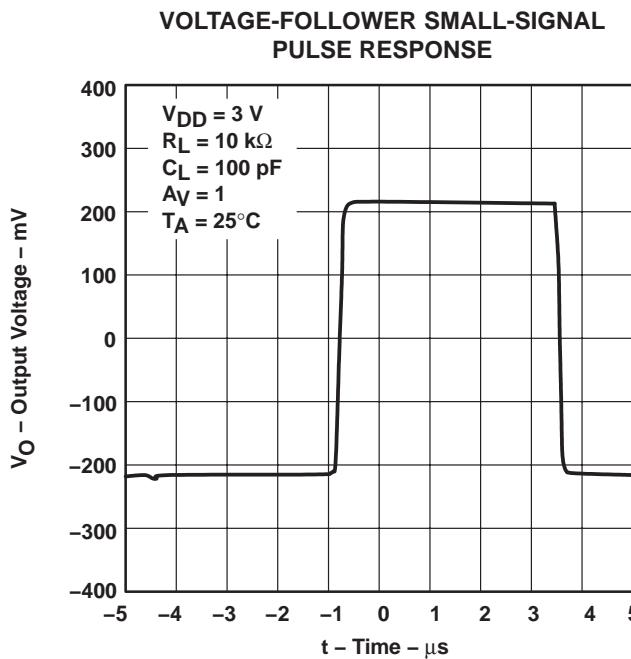


Figure 39

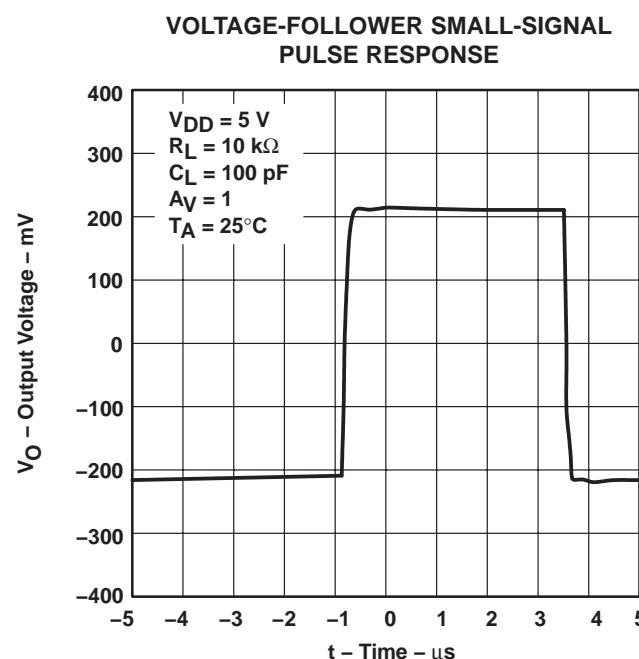


Figure 40

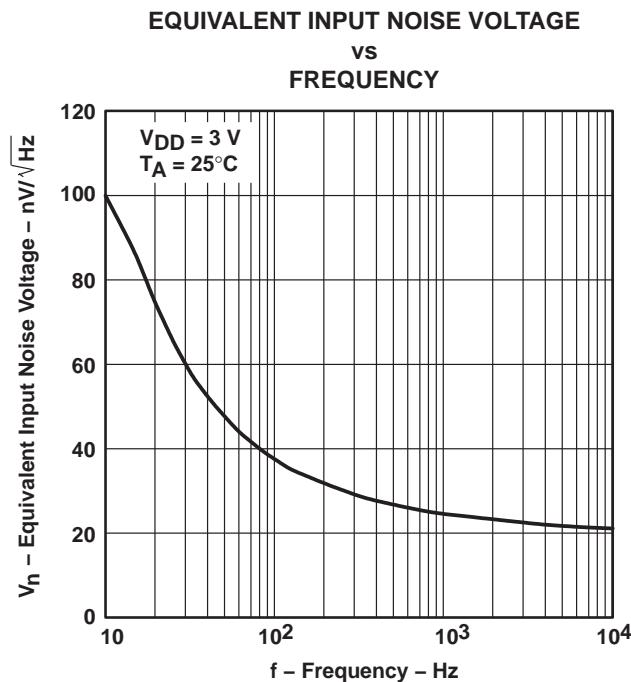


Figure 41

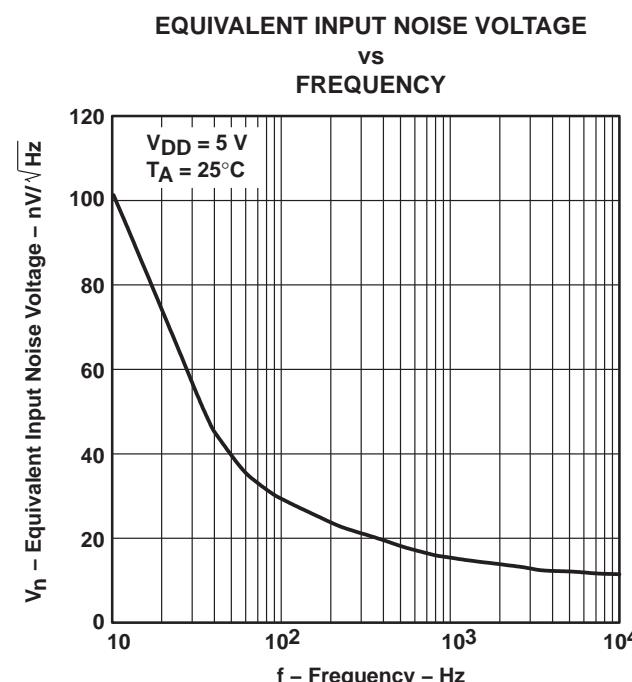


Figure 42

TYPICAL CHARACTERISTICS

NOISE VOLTAGE OVER A 10-SECOND PERIOD

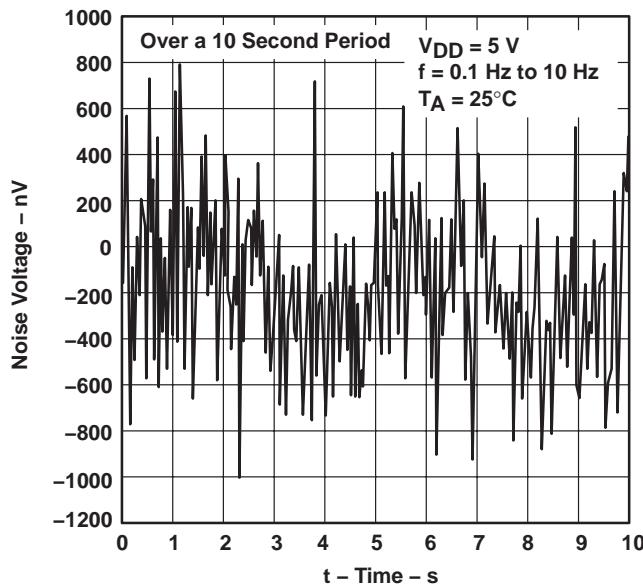


Figure 43

**TOTAL HARMONIC DISTORTION PLUS NOISE
vs
FREQUENCY**

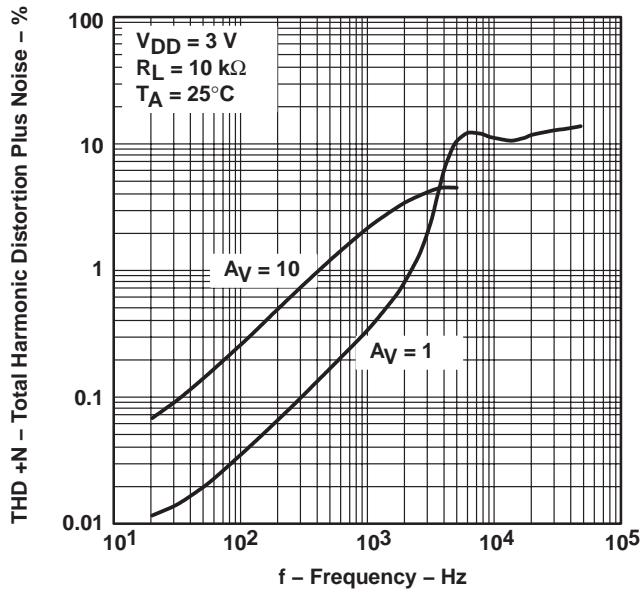


Figure 44

**TOTAL HARMONIC DISTORTION PLUS NOISE
vs
FREQUENCY**

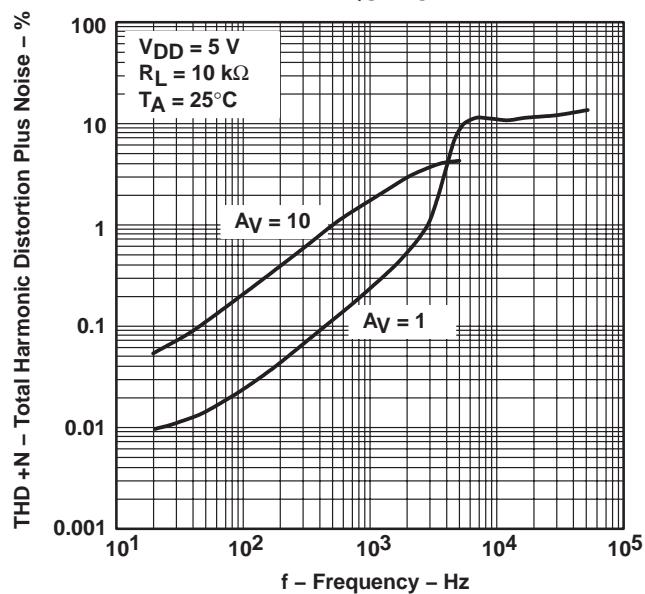


Figure 45

TYPICAL CHARACTERISTICS

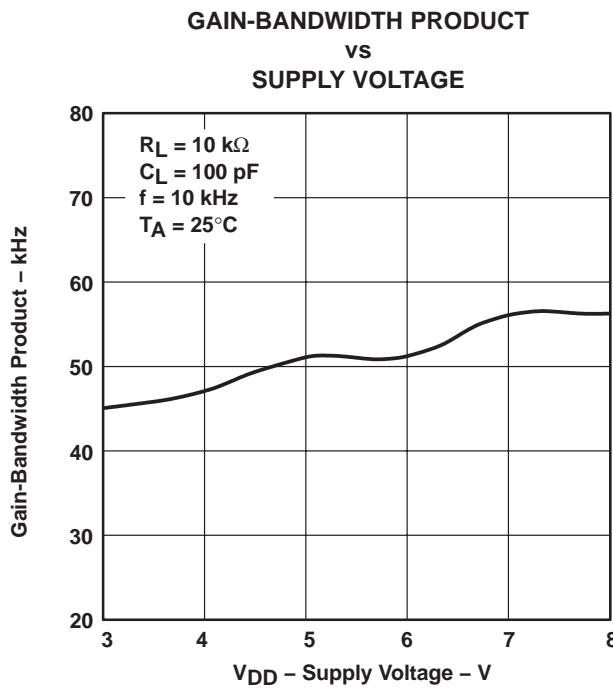


Figure 46

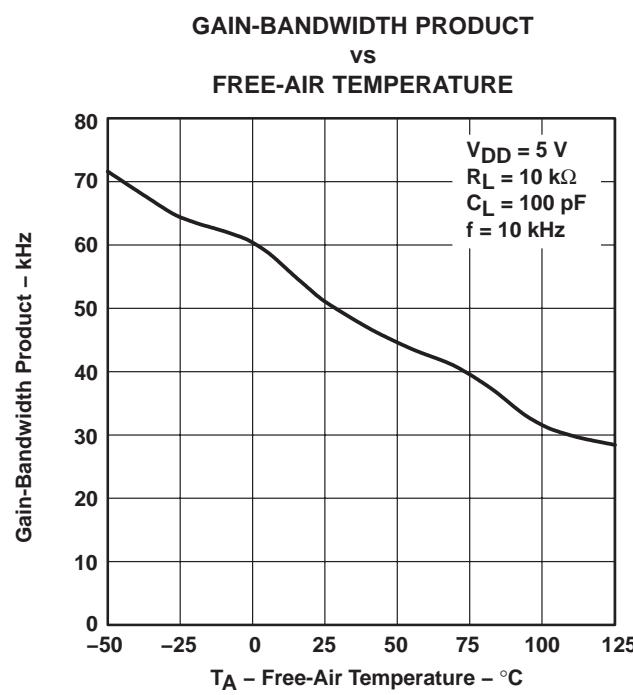


Figure 47

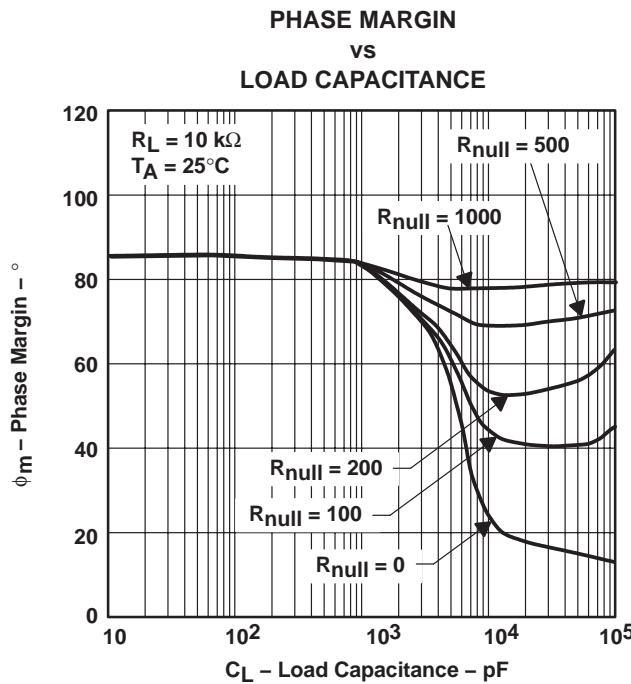


Figure 48

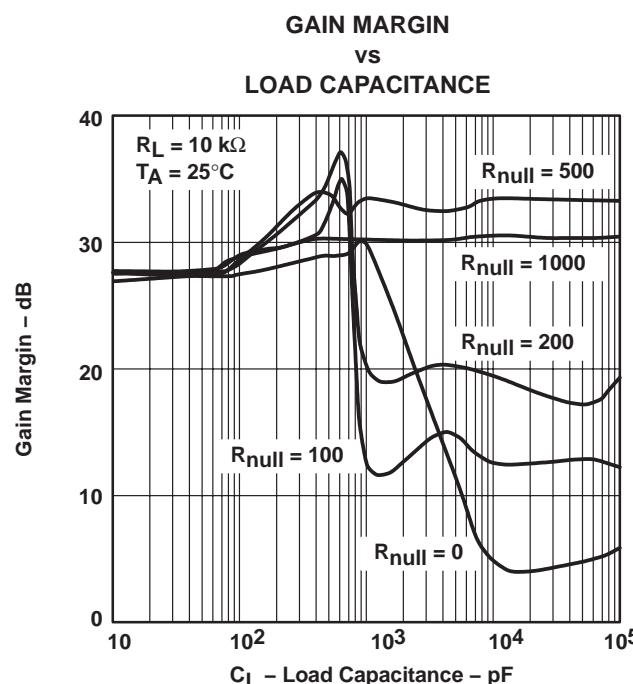


Figure 49

TYPICAL CHARACTERISTICS

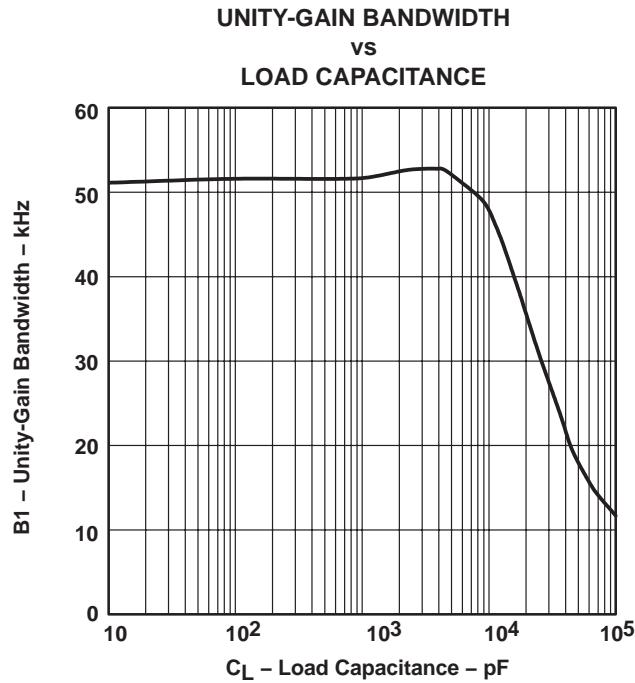


Figure 50

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLV2422QDRG4Q1	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2422Q1	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TLV2422-Q1 :

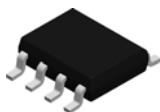
- Catalog : [TLV2422](#)

- Military : [TLV2422M](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

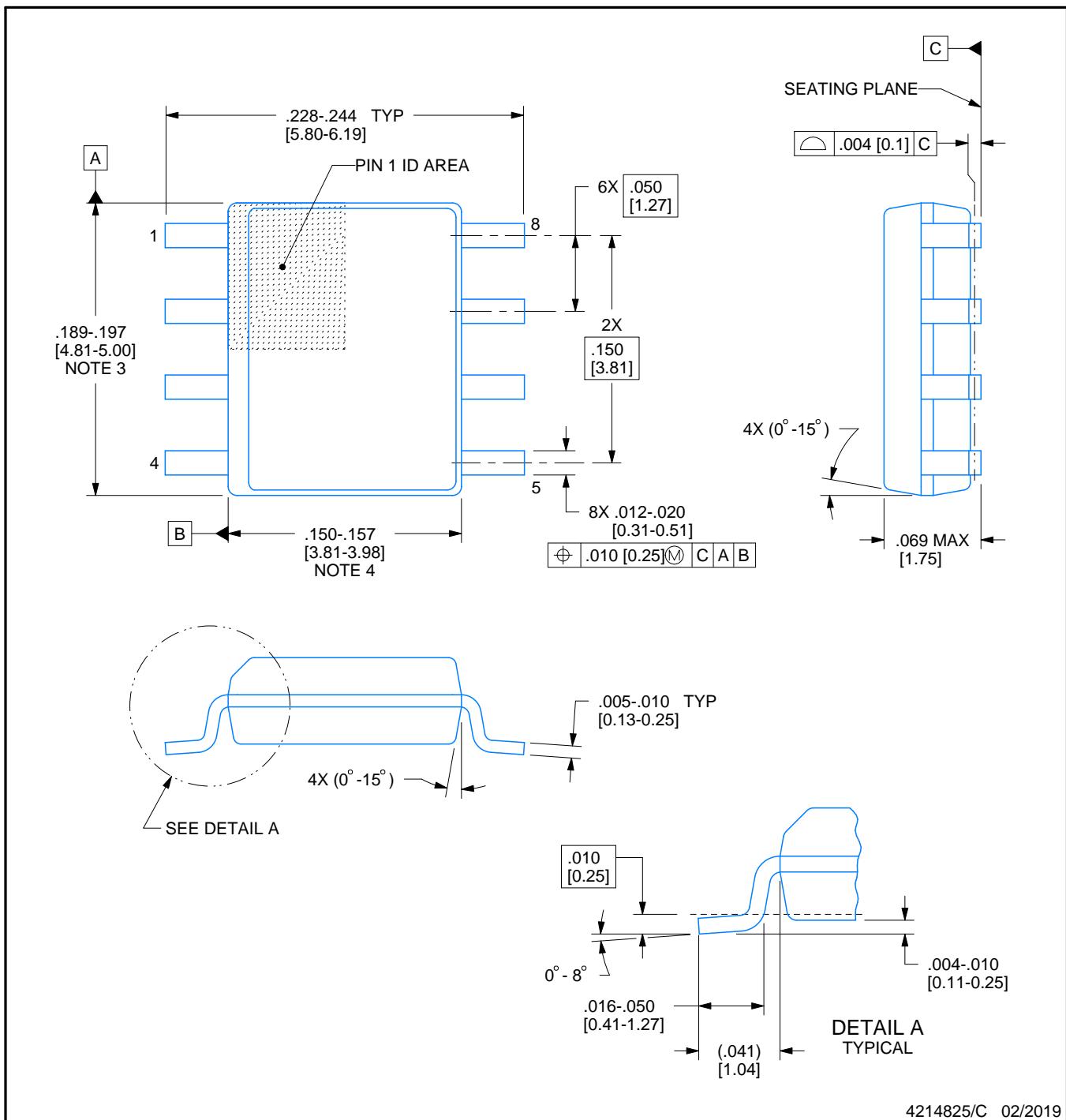
D0008A



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

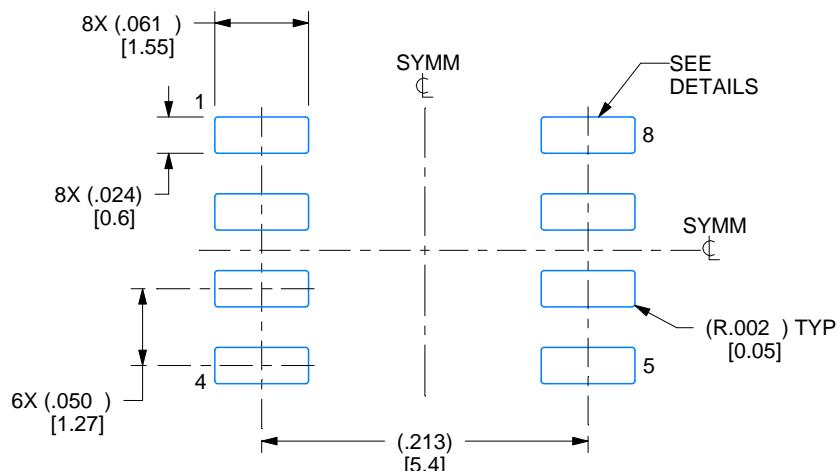
- Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches.
- Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- This dimension does not include interlead flash.
- Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

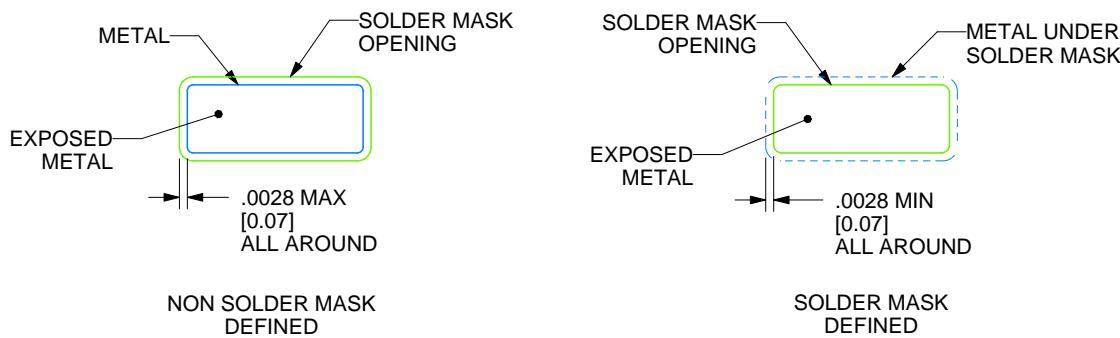
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

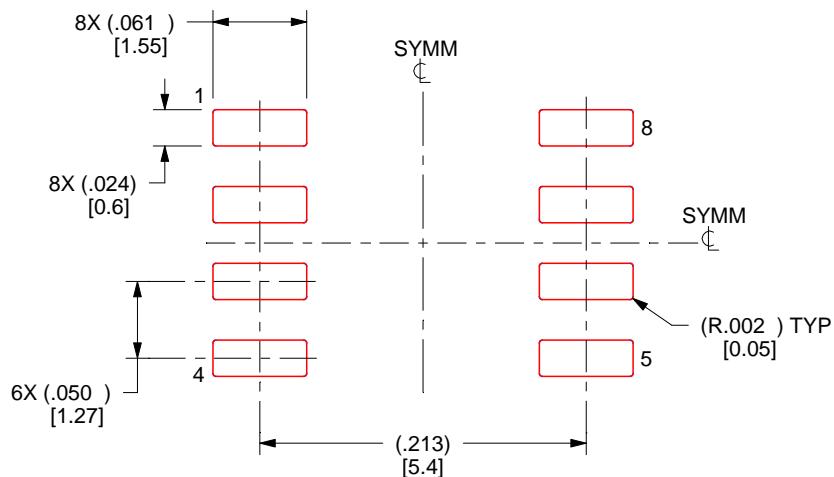
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2024, Texas Instruments Incorporated